

IN THE CLAIMS

Please amend the claims as follows:

Claims 1-21 (Canceled).

Claim 22 (Previously Presented): An electroconductive sheet, comprising:

a substrate layer of a thermoplastic resin comprising an acrylonitrile-butadiene-styrene copolymer resin and/or a polystyrene resin and a polycarbonate resin; and having laminated on at least one side of the substrate layer;

a surface layer of an electroconductive resin composition comprising a polycarbonate resin and from 5 to 50 wt% of a carbon black and optionally a graft resin.

Claim 23 (Previously Presented): An electroconductive sheet of claim 22, wherein the substrate layer further comprises a modifier resin selected from the group consisting of a polyethylene resin, a polypropylene resin, an ethylene-propylene copolymer resin, an ethylene-ethylacrylate copolymer resin, an ethylene-vinyl acetate copolymer resin, a polyethylene terephthalate resin, and a polybutylene terephthalate resin.

Claim 24 (Previously Presented): An electroconductive sheet of claim 22, wherein the polycarbonate resin of the substrate layer is present in an amount of from 1 to 50 wt% based on the thermoplastic resin.

Claim 25 (Previously Presented): An electroconductive sheet of claim 22, wherein the graft resin comprises an ethylene-glycidylmethacrylate copolymer and an acrylonitrile-butadiene-styrene copolymer; and is present in an amount at most 40 wt% based on the polycarbonate resin of the surface layer.

Claim 26 (Previously Presented): An electroconductive sheet of claim 22, wherein the carbon black is selected from the group consisting of furnace black, channel black, and acetylene black.

Claim 27 (Previously Presented): An electroconductive sheet of claim 22, which has a thickness of from 0.1 to 3.0 mm.

Claim 28 (Previously Presented): An electroconductive sheet of claim 22, wherein the surface layer has a surface roughness of from 0.6 μm to 4.0 μm .

Claim 29 (Previously Presented): An electroconductive sheet of claim 22, which has a surface resistivity of from 10^2 to $10^{10} \Omega$ on the side on which the surface layer is laminated.

Claim 30 (Previously Presented): A packaging container for an electronic part, comprising the electroconductive sheet of claim 22.

Claim 31 (Previously Presented): An injection-molded tray, a vacuum-formed tray, a magazine tape or a carrier tape comprising the electroconductive sheet of claim 22.

Claim 32 (Previously Presented): An electroconductive sheet, comprising:
a substrate layer of a thermoplastic resin comprising an acrylonitrile-butadiene-styrene copolymer resin and an electroconductive resin composition comprising a polycarbonate resin and from 5 to 50 wt% of a carbon black and having laminated on at least one side of the substrate layer;
a surface layer comprising the electroconductive resin composition.

Claim 33 (Previously Presented): An electroconductive sheet of claim 32, wherein the substrate layer further comprises a modifier resin selected from the group consisting of a polyethylene resin, a polypropylene resin, an ethylene-propylene copolymer resin, an ethylene-ethylacrylate copolymer resin, an ethylene-vinyl acetate copolymer resin, a polyethylene terephthalate resin, and a polybutylene terephthalate resin.

Claim 34 (Previously Presented): An electroconductive sheet of claim 32, wherein the electroconductive resin of the substrate layer is present in an amount of from 1 to 50 wt% based on the thermoplastic resin.

Claim 35 (Previously Presented): An electroconductive sheet of claim 32, wherein the carbon black is selected from the group consisting of furnace black, channel black, and acetylene black.

Claim 36 (Previously Presented): An electroconductive sheet of claim 32, which has a thickness of from 0.1 to 3.0 mm.

Claim 37 (Previously Presented): An electroconductive sheet of claim 32, wherein the surface layer has a surface roughness of from 0.6 μm to 4.0 μm .

Claim 38 (Previously Presented): An electroconductive sheet of claim 32, which has a surface resistivity of from 10^2 to $10^{10} \Omega$ on the side on which the surface layer is laminated.

Claim 39 (Previously Presented): A packaging container for an electronic part, comprising the electroconductive sheet of claim 32.

Claim 40 (Previously Presented): An injection-molded tray, a vacuum-formed tray, a magazine tape or a carrier tape comprising the electroconductive sheet of claim 32.

Claim 41 (Currently Amended): An electroconductive sheet, comprising:

a polycarbonate resin;

5-50 wt% of a carbon black; and

~~at most 40 wt%~~

1-40 wt% of a graft resin, based on the polycarbonate resin.

Claim 42 (Previously Presented): An electroconductive sheet of claim 41, wherein the polycarbonate resin is selected from the group consisting of an aromatic polycarbonate resin, an aliphatic polycarbonate resin, and an aromatic-aliphatic polycarbonate.

Claim 43 (Previously Presented): An electroconductive sheet of claim 41, further comprising a modifier resin selected from the group consisting of a polyethylene resin, a polypropylene resin, an ethylene-propylene copolymer resin, an ethylene-ethylacrylate

copolymer resin, an ethylene-vinyl acetate copolymer resin, a polyethylene terephthalate resin, and a polybutylene terephthalate resin.

Claim 44 (Previously Presented): An electroconductive sheet of claim 41, wherein the carbon black is selected from the group consisting of furnace black, channel black, and acetylene black.

Claim 45 (Previously Presented): An electroconductive sheet of claim 41, wherein the graft resin comprises an ethylene-glycidylmethacrylate copolymer resin and an acrylonitrile-butadiene-styrene copolymer resin.

Claim 46 (Previously Presented): An electroconductive sheet of claim 41, which has a thickness of from 0.1 to 3.0 mm.

Claim 47 (Previously Presented): An electroconductive sheet of claim 41, wherein the surface layer has a surface roughness of from 0.6 μm to 4.0 μm .

Claim 48 (Currently Amended): An electroconductive sheet of claim 41, which has a surface resistivity of from 10^2 to $10^{10} \Omega$ on ~~the~~ a side on which ~~the~~ a surface layer is laminated.

Claim 49 (Previously Presented): A packaging container for an electronic part, comprising the electroconductive sheet of claim 41.

Claim 50 (Previously Presented): An injection-molded tray, a vacuum-formed tray, a magazine tape or a carrier tape comprising the electroconductive sheet of claim 41.

Claim 51 (New): An electroconductive sheet of claim 41, wherein the graft resin is present in an amount of from 3-40 wt% based on the polycarbonate resin.